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## PowerTrench<sup>®</sup> Power Clip 30 V Asymmetric Dual N-Channel MOSFET

#### Features

Q1: N-Channel

• Max  $r_{DS(on)}$  = 9.6 m $\Omega$  at V<sub>GS</sub> = 4.5 V, I<sub>D</sub> = 10 A

Q2: N-Channel

- Max  $r_{DS(on)}$  = 2.7 m $\Omega$  at V<sub>GS</sub> = 4.5 V, I<sub>D</sub> = 22 A
- Low inductance packaging shortens rise/fall times, resulting in lower switching losses
- MOSFET integration enables optimum layout for lower circuit inductance and reduced switch node ringing
- RoHS Compliant

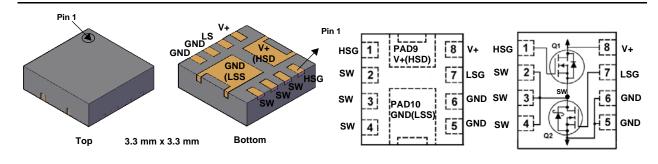


#### **General Description**

This device includes two specialized N-Channel MOSFETs in a dual package. The switch node has been internally connected to enable easy placement and routing of synchronous buck converters. The control MOSFET (Q1) and synchronous SyncFET<sup>TM</sup> (Q2) have been designed to provide optimal power efficiency.

#### Applications

- Computing
- Communications
- General Purpose Point of Load



#### MOSFET Maximum Ratings T<sub>A</sub> = 25 °C unless otherwise noted

Symbol	Parameter		Q1	Q2	Units	
V <sub>DS</sub>	Drain to Source Voltage		30	30	V	
V <sub>GS</sub>	Gate to Source Voltage	(Note 4)	±20	±20	V	
	Drain Current -Continuous (Package limited)	T <sub>C</sub> = 25 °C	20	55		
I <sub>D</sub>	-Continuous	T <sub>A</sub> = 25 °C	13 <sup>1a</sup>	26 <sup>1b</sup>	Α	
	-Pulsed		40	100		
E <sub>AS</sub>	Single Pulse Avalanche Energy	(Note 3)	21	97	mJ	
D	Power Dissipation for Single Operation	T <sub>A</sub> = 25 °C	1.6 <sup>1a</sup>	2.0 <sup>1b</sup>	14/	
P <sub>D</sub>	Power Dissipation for Single Operation	$T_{A} = 25 \ ^{\circ}C \qquad 0.8^{1c}$		0.9 <sup>1d</sup>	W	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range		-55 to	+150	°C	

#### **Thermal Characteristics**

$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	77 <sup>1a</sup>	63 <sup>1b</sup>	
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	151 <sup>1c</sup>	135 <sup>1d</sup>	°C/W
$R_{\theta JC}$	Thermal Resistance, Junction to Case	5.0	3.5	

#### Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
13CF/15CF	FDPC8013S	Power Clip 33	13 "	12 mm	3000 units

October 2014

Symbol	Parameter	Test Conditions	Туре	Min	Тур	Max	Units
Off Chara	cteristics						
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	$I_D = 250 \ \mu A, V_{GS} = 0 \ V$ $I_D = 1 \ m A, V_{GS} = 0 \ V$	Q1 Q2	30 30			V
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C $I_D = 10 \ m$ A, referenced to 25 °C	Q1 Q2		16 20		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 24 V, V_{GS} = 0 V$ $V_{DS} = 24 V, V_{GS} = 0 V$	Q1 Q2			1 500	μΑ μΑ
I <sub>GSS</sub>	Gate to Source Leakage Current, Forward	$V_{GS} = 20 V, V_{DS} = 0 V$ $V_{GS} = 20 V, V_{DS} = 0 V$	Q1 Q2			100 100	nA nA
On Chara	cteristics						
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}$ , $I_D = 250 \ \mu A$ $V_{GS} = V_{DS}$ , $I_D = 1 \ m A$	Q1 Q2	1.2 1.2	1.5 1.7	3.0 3.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C $I_D = 10 \ m$ A, referenced to 25 °C	Q1 Q2		-5 -6		mV/°C
r.	Drain to Source On Resistance		Q1		4.6 6.7 6.6	6.4 9.6 9.2	mΩ
r <sub>DS(on)</sub>	Drain to Source On Resistance	$V_{GS} = 10 \text{ V}, \text{ I}_D = 26 \text{ A}$ $V_{GS} = 4.5 \text{ V}, \text{ I}_D = 22 \text{ A}$ $V_{GS} = 10 \text{ V}, \text{ I}_D = 26 \text{ A}, \text{T}_J = 125 \text{ °C}$	Q2		1.4 2.0 1.9	1.9 2.7 2.6	11152
9fs	Forward Transconductance	$V_{DS} = 5 V, I_D = 13 A$ $V_{DS} = 5 V, I_D = 26 A$	Q1 Q2		53 168		S

#### **Dynamic Characteristics**

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			<u></u>	007	
C <sub>iss</sub>	Input Capacitance	Q1:	Q1	827	рF
OISS	input oupublication	V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 0 V, f = 1 MHZ	Q2	2785	рі
C	Output Capacitanaa		Q1	333	рF
C <sub>oss</sub>	Output Capacitance	Q2:	Q2	997	ρг
0	Deverse Transfer Conscitor of	V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 0 V, f = 1 MHZ	Q1	44	- <b>F</b>
C <sub>rss</sub>	Reverse Transfer Capacitance		Q2	128	pF
D	Gate Resistance		Q1	0.5	Ω
R <sub>g</sub>	Gale Resistance		Q2	0.5	22

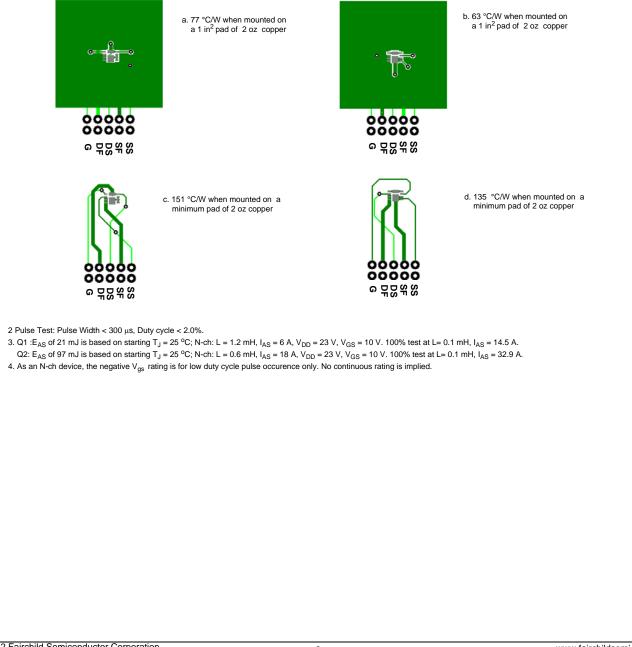
#### **Switching Characteristics**

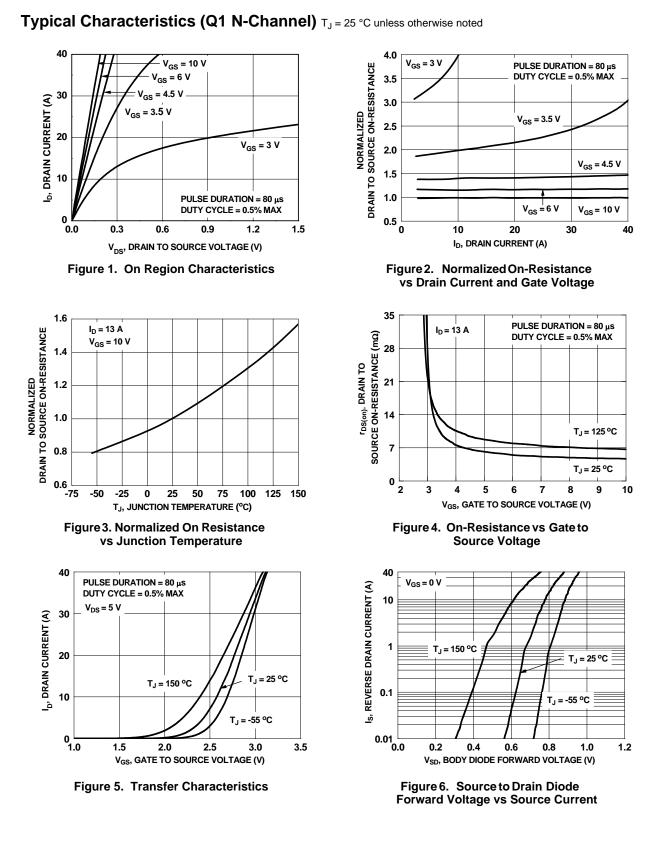
t <sub>d(on)</sub>	Turn-On Delay Time			Q1 Q2	6 11	ns
t <sub>r</sub>	Rise Time	Q1: V <sub>DD</sub> = 15 V, I <sub>D</sub> = 13	8 A, R <sub>GEN</sub> = 6 Ω	Q1 Q2	2 5	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	Q2: V <sub>DD</sub> = 15 V, I <sub>D</sub> = 26	SA Room = 60	Q1 Q2	16 30	ns
t <sub>f</sub>	Fall Time		7, NGEN – 0 32	Q1 Q2	2 4	ns
Qg	Total Gate Charge	$V_{GS} = 0$ V to 10 V		Q1 Q2	13 44	nC
Qg	Total Gate Charge	$V_{GS} = 0$ V to 4.5 V	V <sub>DD</sub> = 15 V, ′ I <sub>D</sub> = 13 A	Q1 Q2	6 21	nC
Q <sub>gs</sub>	Gate to Source Gate Charge		Q2 V <sub>DD</sub> = 15 V,	Q1 Q2	2.2 7.2	nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge		$I_{\rm D} = 26  {\rm A}$	Q1 Q2	1.9 6.6	nC

FDPC8013S PowerTrench<sup>®</sup> Power Clip

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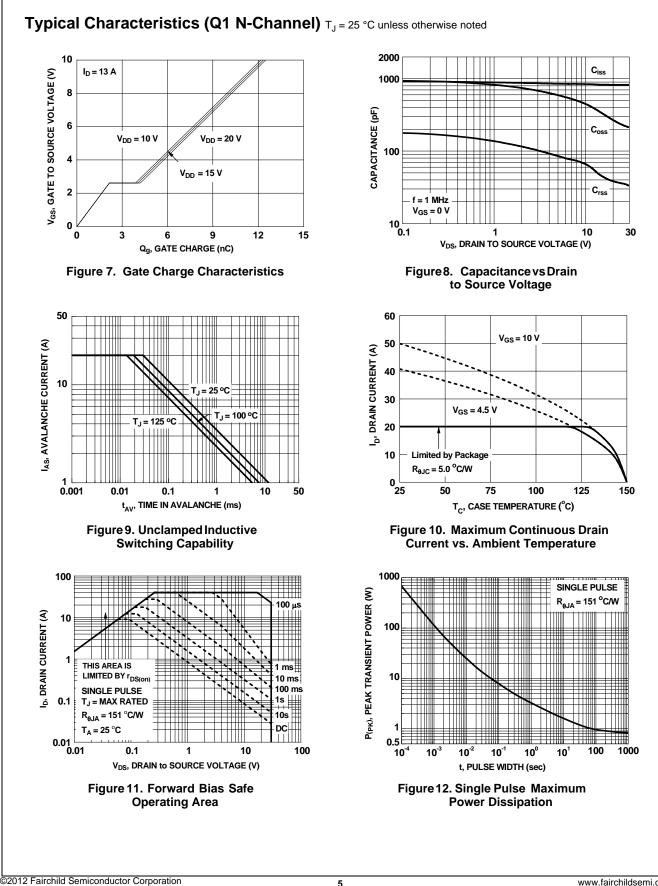
Symbol	Parameter	Test Conditions	Туре	Min	Тур	Max	Units		
Drain-Source Diode Characteristics									
V <sub>SD</sub>	Source to Drain Diode Forward Voltage		Q1 Q2		0.80 0.77	1.2 1.2	V		
t <sub>rr</sub>	Reverse Recovery Time	Q1 I <sub>F</sub> = 13 A, di/dt = 100 A/μs	Q1 Q2		22 29		ns		
Q <sub>rr</sub>	Reverse Recovery Charge	Q2 I <sub>F</sub> = 26 A, di/dt = 300 A/μs	Q1 Q2		7 30		nC		



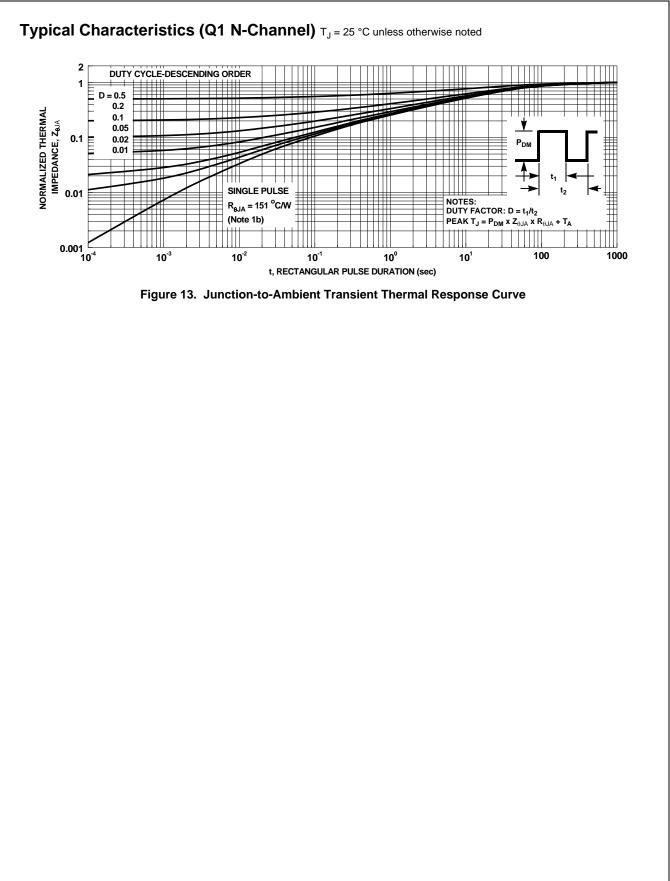


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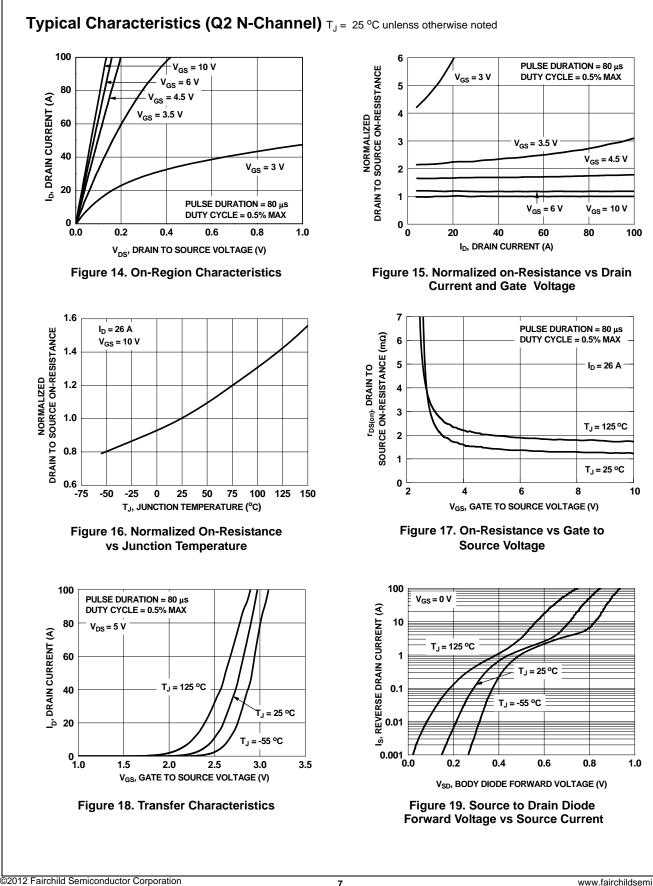




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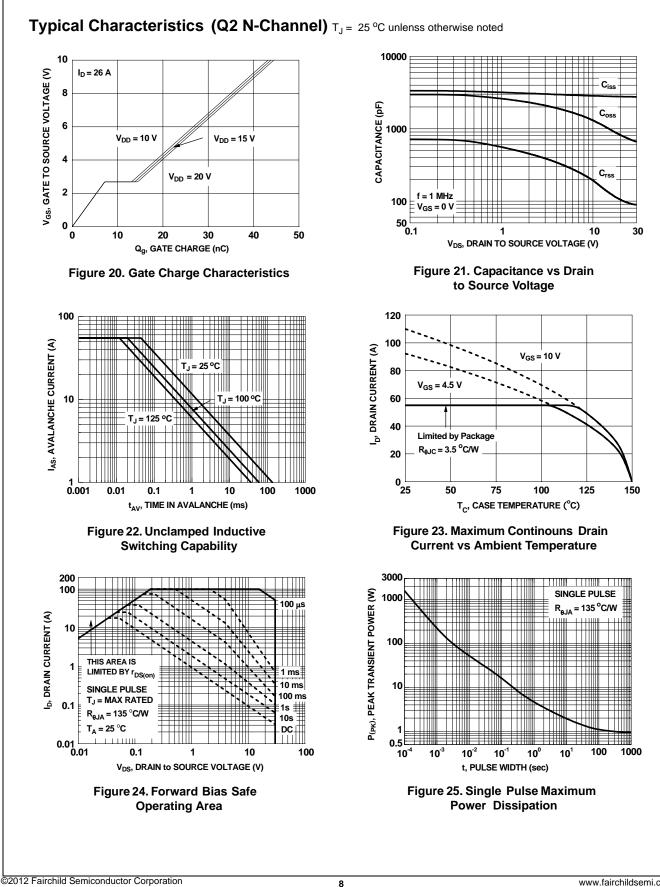
FDPC8013S PowerTrench<sup>®</sup> Power Clip



FDPC8013S Rev.C2

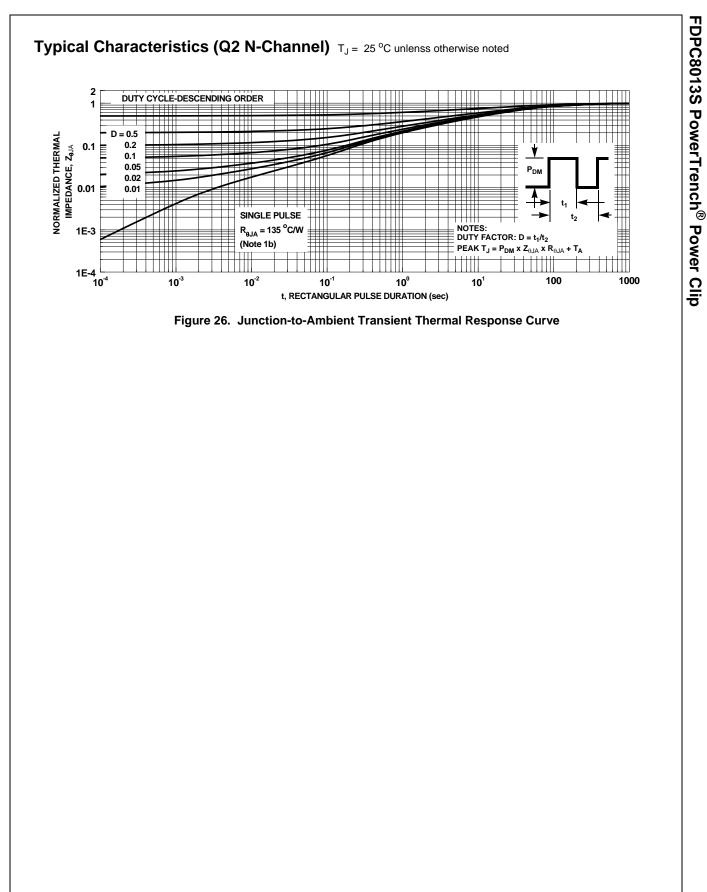
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## Typical Characteristics (continued)

### SyncFET<sup>™</sup> Schottky body diode Characteristics

30

25

20

15

10 5

0

-5 \_\_\_\_\_ 100

CURRENT (A)

Fairchild's SyncFET<sup>TM</sup> process embeds a Schottky diode in parallel with PowerTrench MOSFET. This diode exhibits similar characteristics to a discrete external Schottky diode in parallel with a MOSFET. Figure 27 shows the reverse recovery characteristic of the FDPC8013S.

Schottky barrier diodes exhibit significant leakage at high temperature and high reverse voltage. This will increase the power in the device.

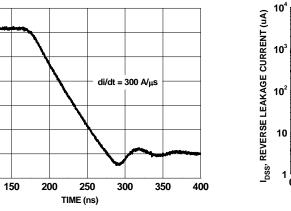


Figure 27. FDPC8013S SyncFET<sup>™</sup> body diode reverse recovery characteristic

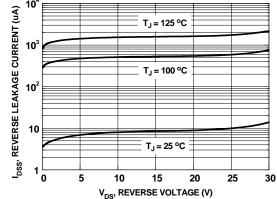
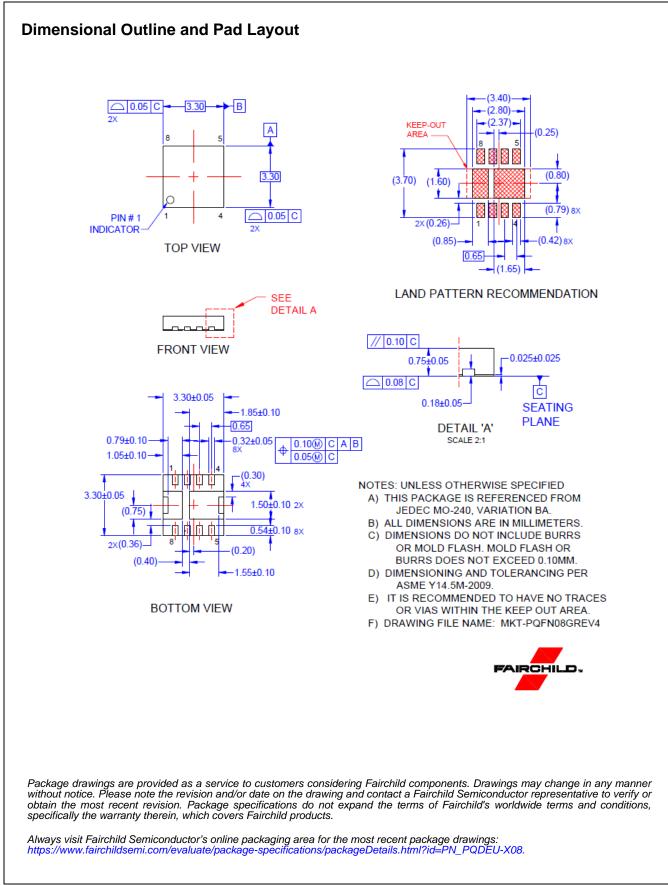
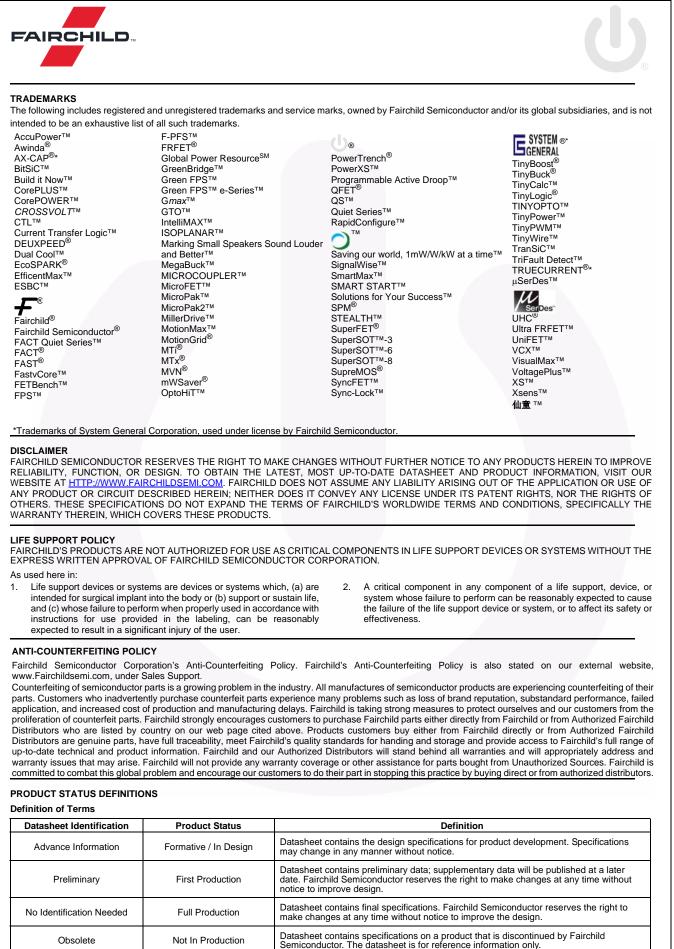


Figure 28. SyncFET<sup>TM</sup> body diode reverse leakage versus drain-source voltage

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